

Ehlbeek 15a 30938 Burgwedel fon 05139-9980-0 fax 05139-9980-49

www.powerbridge.de

### **GAP-151R-S8**

# 1U Rugged Edge Server- Rear I/O & Rear Power supply Dual Socket 5<sup>th</sup>/4<sup>th</sup> Gen Intel<sup>®</sup> Xeon<sup>®</sup> Scalable Processors





GAP is a product family of Rugged aluminium Servers and Workstations designed for Edge applications that require a robust MIL-GRADE certified computing platform, suitable for operations in critical environments.

1U PLATFORM 510 MM

2

4TE

UP TO 9 HOT SWAP SSD

2 I/O Boards

GAP-151R-S8 Rugged Edge Servers are powered by dual-socket 5<sup>th</sup> Gen Intel® Xeon® / 4<sup>th</sup> Gen Intel® Xeon® Scalable Processors renowned for their robust architecture with enhanced AI acceleration and advanced security capabilities. Offering improved performance and efficiency, these servers are tailored to meet the demanding requirements of modern computing environments at the Edge. The integrated IPMI services support monitoring, control, and management functions, sending alarm notifications in case of critical events.

GAP-151R-S8 are designed for 19" rackmounting and have a 1U chassis with a total overall depth of 540mm. Notably, the 19" front brackets of the chassis are strategically positioned in a backward orientation, reducing the required cabinet space to just 510mm once fully installed.

The rear I/O and rear power supply configuration offers versatile storage options, including two on board M.2 NVME SSD and either up to three removable 2.5" SAS SSD, six removable U.2 NVMe SSD or up to nine removable 2.5" SATA SSDs.

Moreover, this rugged server can accommodate up to two full-height half lenght PCIe x16 cards.

For enhanced protection against shocks and vibrations, additional boards can be supplied with a dedicated retainer kit, ensuring optimal safety even during transport.

Built to meet MIL-STD-810F standards for temperature and shock resistance, as well as MIL-STD-167-1A standards for vibration tolerance, GAP Rugged Edge Servers ensure reliable operation under the challenging conditions often found at the Edge. Additionally, they can optionally be configured to comply with MIL-STD-461 standards for EMI/EMC, featuring MIL-grade connectors for either the power input or both the I/O connectors and power supply inputs.

All units are shipped with an inventory list to guarantee configuration control and reproducibility over time. Additionally, upon request, all server configurations can undergo specific thermal or mechanical environmental stress tests.



## Technical Specifications



$\sim$		
6.1	/et	am
$\mathbf{O}$	/ <b>3</b> t	CHI

СРИ	5 <sup>th</sup> Gen Intel <sup>®</sup> Xeon <sup>®</sup> / 4 <sup>th</sup> Gen Intel <sup>®</sup> Xeon <sup>®</sup> Scalable processors, Dual Socket LGA- 4677 (Socket E) supported, CPU TDP Up to 205W TDP
Memory	Up to 4TB ECC RDIMM, DDR5-4800MT/s in 16 DIMM slots
Chipset	Intel® C741
Graphics	1 Aspeed AST2600 BMC port
Network Connectivity	1 x Dedicated IPMI LAN port 2 x AIOM slots supporting 100GbE / 25GbE / 2.5GbE / GbE ports OCP 3.0 NICs
Storage	Internal: 2 x NVMe M.2, M-Key, 2280 Removable: Up to 3x 2.5" SAS SSD or Up to 6x U.2 NVMe SSD or Up to 9x 2.5" SATA SSD
TPM	1x TPM Header
Motherboard I/O shield	1 x VGA, 2 x USB 3.0, 1 x IPMI; 1 x COM (available on the rear panel)
Expansion slots	2x PCle 5.0 x16 FHHL
Operative Systems	Windows® 11 IoT Enterprise, Windows® 10 IoT Enterprise LTSC, Windows® Server
	2022, Windows® Server 2019, Linux
IPMI	
IPMI Remote Monitoring	IPMI2.0, SPM, Watchdog; SNMP and e-mail

#### Power Supply

Dower Cumply	AC or DC Redundant Power Supply -
Power Supply	Optional AC Single

#### Mechanical

Dimensions	483 x 44 x 510 mm 540 mm full depth (W x H x D)
Material	Aluminum with surface passivation treatment
Colour	Black / RAL 9005 - Powder Coating
Mounting	1U 19" rackmount chassis Optional Telescopic slides
Configuration	Rear I/O - Rear Power Supply
Front Panel Leds / Buttons / Connectors	Power On/Off button with LED Reset button with LED 2x USB 3.0
Fans	6x internal PWM fans

#### Environmental - (Design to meet)

	intai (Boorgii to illoot)
Operating Temperatures	0°C to +50°C MIL-STD-810H, Method 501.7 & 502.7 -20°C to +60°C (depending on configuration)
Storage Temperature	-40°C to +70°C MIL-STD-810H, Method 501.7 & 502.7
Humidity	5% – 95% non-condensing MIL-STD-810H 507.6
Operating Vibrations	MIL-STD-167-1A, Type I
Not Operating Vibrations	1.17 Grms, 5-500 Hz MIL-STD-810H, Method 514.8
Operating Shocks	20g / 11ms – half sine MIL-STD-810G, Method 516.7
EMC	Directive 2014/35/UE-LVD   Directive 2014/30/UE-EMC   Directive 2011/65/UE - RoHS Regulation EC No 1907/2006   MIL-STD-461G (on request)

GAP servers and workstations are designed in accordance with the environmental specifications indicated. Some parameters depend on the configuration. Equipment may be subjected to dedicated test profiles.